Superior high Flux for High Current System

Z Power LED - Z5-M0

SZ5-M0-WX-XX (Cool, Neutral, Warm)





### **Product Brief**

### **Description**

- The Z-Power series is designed for high flux output applications with high current operation capability.
- It incorporates state of the art SMD design and low thermal resistant material.
- The Z Power LED is ideal light sources for directional lighting applications such as Spot Lights, various outdoor applications, automotive lightings and high performance torches.

#### **Features and Benefits**

- Super high Flux output and high Luminance
- Designed for high current operation
- SMT solderable
- RoHS compliant

### **Key Applications**

- Indoor lighting
- Outdoor lighting
- Automotive
- · Architectural lighting
- Industrial lighting (High/Low bay)
- Portable Torch
- · Home appliance

**Table 1. Product Selection Table** 

Part Number			CRI		
Part Number	Color	Min.	Тур.	Max.	Min
SZ5-M0-W0-00	Cool White	4700K	5300K	7000K	70
SZ5-M0-W0-C8	Neutral White	4700K	5300K	7000K	80
SZ5-M0-WN-00	Neutral White	3700K	4000K	4700K	70
SZ5-M0-WN-C8	Neutral White	3700K	4000K	4700K	80
SZ5-M0-WN-C9	Neutral White	3700K	4000K	4700K	90
SZ5-M0-WW-C8	Warm White	2600K	3000K	3700K	80
SZ5-M0-WW-C9	Warm White	2600K	2700K	3700K	90



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### **Performance Characteristics**

Table 2. Product Selection Guide, T<sub>i</sub> = 25°C, RH30%

Part Number	ССТ (К) <sup>[1]</sup>	Typical Luminous Flux <sup>[2]</sup> Φ <sub>v</sub> <sup>[3]</sup> (Im)		T)	CRI <sup>[5]</sup> , R <sub>a</sub>			
	Тур.	350mA	700mA	1200mA	350mA	700mA	1200mA	Min.
SZ5-M0-W0-00	5300	142	258	401	2.95	3.14	3.33	70
SZ5-M0-W0-C8	5300	135	245	382	2.95	3.14	3.33	80
SZ5-M0-WN-00	4000	140	254	396	2.95	3.14	3.33	70
SZ5-M0-WN-C8	4000	122	222	345	2.95	3.14	3.33	80
SZ5-M0-WN-C9	4000	95	173	268	2.95	3.14	3.33	90
SZ5-M0-WW-C8	3000	116	211	328	2.95	3.14	3.33	80
SZ5-M0-WW-C9	2700	93	169	263	2.95	3.14	3.33	90

Table 3. Product Selection Guide, T<sub>i</sub> = 85°C

Part Number	CCT (K)	Typical Luminous Flux <sup>[2]</sup> Φ <sub>v</sub> <sup>[3]</sup> (lm)			•	/pical Forwar /oltage (V <sub>F</sub> ) <sup>[4</sup>	
	Тур.	350mA	700mA	1200mA	350mA	700mA	1200mA
SZ5-M0-W0-00	5300	129	234	364	2.78	2.96	3.14
SZ5-M0-W0-C8	5300	122	223	347	2.78	2.96	3.14
SZ5-M0-WN-00	4000	127	231	360	2.78	2.96	3.14
SZ5-M0-WN-C8	4000	111	202	313	2.78	2.96	3.14
SZ5-M0-WN-C9	4000	86	157	243	2.78	2.96	3.14
SZ5-M0-WW-C8	3000	105	192	298	2.78	2.96	3.14
SZ5-M0-WW-C9	2700	84	153	239	2.78	2.96	3.14

#### Notes:

- (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. Color coordinate:  $\pm 0.005$ , CCT  $\pm 5\%$  tolerance.
- (2) SSC maintains a tolerance of  $\pm 7\%$  on flux and power measurements.
- (3)  $\Phi_V$  is the total luminous flux output as measured with an integrating sphere.
- (4) Tolerance is  $\pm 0.06$ V on forward voltage measurements.
- (5) Tolerance is  $\pm 2.0$  on CRI measurements.

## **Performance Characteristics**

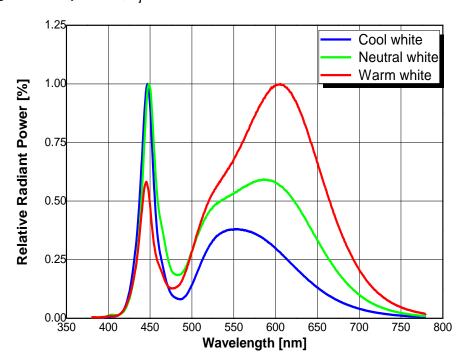
Table 4. Absolute Maximum Ratings T<sub>j</sub> = 25°C, RH30%

Dozemeter	Campbal		Unit		
Parameter	Symbol	Min.	Тур.	Max.	
Forward Current [1]	I <sub>F</sub>	-	-	1500	mA
Peak Pulsed Forward Current [2]	I <sub>F</sub>			2000	mA
Reverse Voltage	$V_R$	-	-	5	V
Power Dissipation	$P_d$	-	-	5.22	W
Junction Temperature	T <sub>j</sub>	-	-	150	°С
Operating Temperature	$T_{opr}$	- 40	-	125	۰C
Storage Temperature	$T_{stg}$	- 40	-	125	۰C
Viewing angle	θ		120		degree
Thermal resistance (J to S) [3]	Rθ <sub>J-S</sub>	-	4.5	-	K/W
ESD Sensitivity(HBM) [4]		Class	3A JESD22-A	114-E	

#### Notes:

- (1) At Junction Temperature 25 °C condition.
- (2) Pulse width ≤10ms, duty cycle ≤ 10% condition.
- (3)  $R\theta_{J-S}$  is tested at 350mA.
- (4) The zener diode is included to protect the product from ESD.

Fig 1. Color Spectrum, T<sub>i</sub> = 25°C



**Fig.2 Typical Spatial Distribution** 

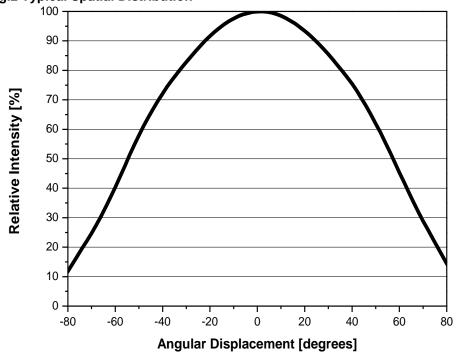


Fig 3. Forward Voltage vs. Forward Current,  $T_j = 25^{\circ}\text{C}$ 

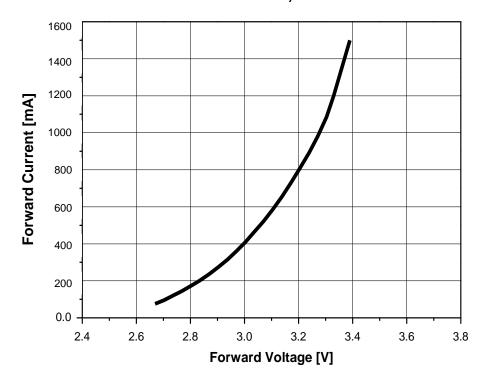


Fig 4. Forward Current vs. Relative Luminous Flux, T<sub>i</sub> = 25°C

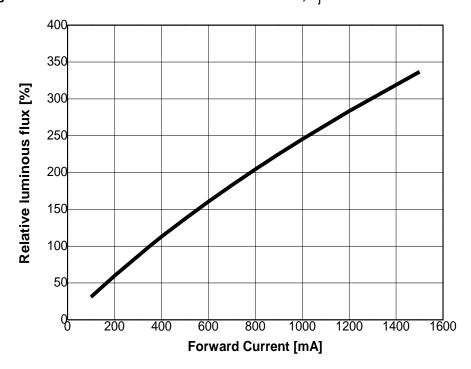


Fig 5. Forward Current vs. CIE x, y Shift, T<sub>i</sub> = 25°C

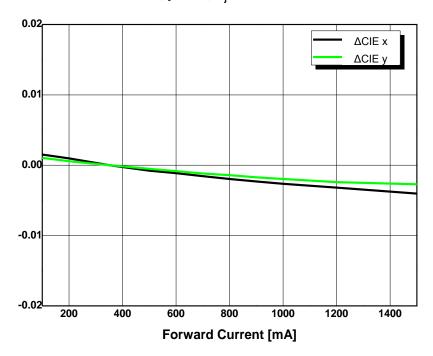


Fig 6. Junction Temp. vs. CIE x, y Shift,  $I_F = 350 \text{mA}$ 

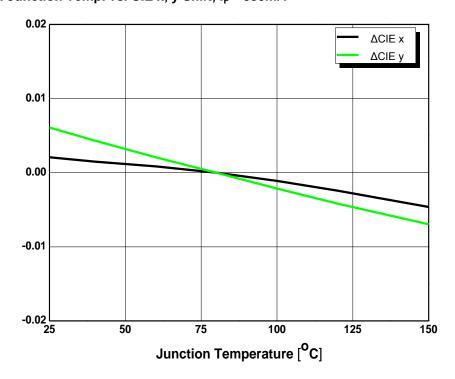


Fig 7. Relative Light Output vs. Junction Temperature,  $I_F = 350 \text{mA}$ 

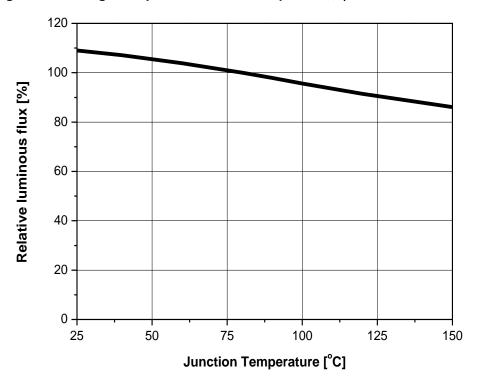


Fig 8. Relative Forward vs. Junction Temperature, I<sub>F</sub> = 350mA

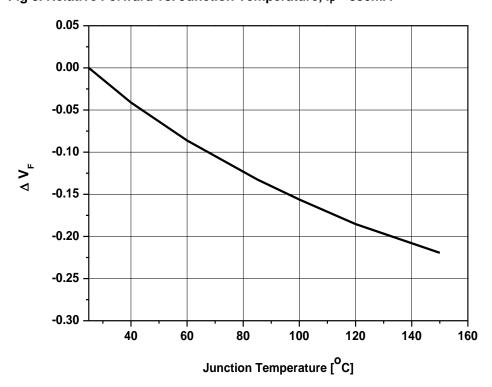
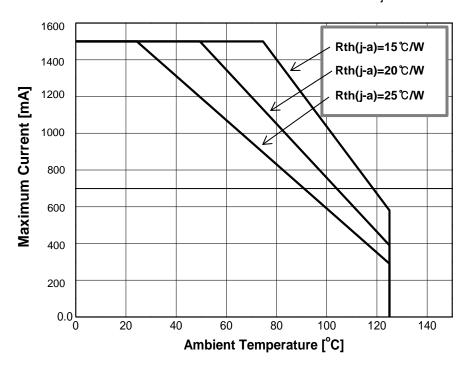


Fig 9. Maximum Forward Current vs. Ambient Temperature,  $T_j(max.) = 150\,^{\circ}\mathrm{C}$ ,  $I_F = 1500\mathrm{mA}$ 



## **Color Bin Structure**

Table 5. Bin Code description,  $T_j$ =25  $^{\circ}$ C,  $I_F$ =350mA

Part Number	Lumir	nous Flux (	Chromaticity			ical Forward oltage (V <sub>F</sub> )	ı
	Bin Code	Min.	Max.	Coordinate	Bin Code	Min.	Max.
	V1	118.5	130		G	2.75	3.00
SZ5-M0-W0-00	V2	130	140	Refer to page.13	———	3.00	3.25
323-100-000	V3	140	150	Kelel to page. 13		3.00	3.23
	W1	150	160		l	3.25	3.50
	V1	118.5	130		G	2.75	3.00
SZ5-M0-W0-C8	V2	130	140	Pofor to page 12	———	3.00	3.25
323-1010-000-08	V3	140	150	Refer to page.13		3.00	3.25
	W1	150	160		I	3.25	3.50
	V1	118.5	130		G	2.75	3.00
SZ5-M0-WN-00	V2	130	140	Refer to page.14	———	3.00	3.25
325-1010-0010-00	V3	140	150	Refer to page. 14		3.00	3.25
	W1	150	160		I	3.25	3.50
	U3	109	118.5		G	2.75	3.00
SZ5-M0-WN-C8	V1	118.5	130	Refer to page.14	———	3.00	3.25
323-1010-0010-00	V2	130	140	Refer to page. 14		3.00	3.25
	V3	140	150		I	3.25	3.50
	T2	80	91		G	2.75	3.00
SZ5-M0-WN-C9	U1	91	100	Pofor to page 14			
323-1010-0010-09	U2	100	109	Refer to page.14	Н	3.00	3.25
	U3	109	118.5		I	3.25	3.50
	U2	100	109		G	2.75	3.00
SZ5-M0-WW-C8	U3	109	118.5	Pofor to page 15	———	3 00	2 25
323-1010-0000-08	V1	118.5	130	Refer to page.15		3.00	3.25
	V2	130	140		I	3.25	3.50
	T1	70	80		G	2.75	3.00
\$75 MO WW CO	T2	80	91	Pefer to page 45		2.00	2.25
SZ5-M0-WW-C9	U1	91	100	Refer to page.15	Н	3.00	3.25
	U2	100	109		I	3.25	3.50

## **Color Bin Structure**

Table 6. Flux Bin Code description,  $T_j$ =85  $^{\circ}$ C

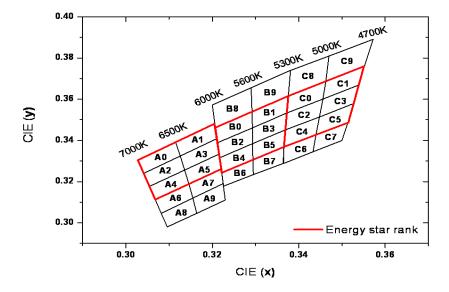
Luminous Flux (lm)								
Bin Code	350n	1 <b>A</b>	700mA					
Bill Code	Min.	Max.	Min.	Max.				
T1	65	74	117	134				
T2	74	84	134	152				
U1	84	92	152	167				
U2	92	100	167	182				
U3	100	109	182	193				
V1	109	119	193	205				
V2	119	129	205	218				
V3	129	138	218	240				
W1	138	147	240	256				
W2	147	156	256	272				

Table 7. VF Bin Code description,  $T_j$ =85  $^{\circ}$ C

Forward Voltage (V <sub>F</sub> )									
Bin Code	350	mA	700mA						
Bill Code	Min.	Max.	Min.	Max.					
G	2.60	2.82	2.77	3.02					
Н	2.82	3.06	3.02	3.27					
I	3.06	3.30	3.27	3.52					

## **Color Bin Structure**

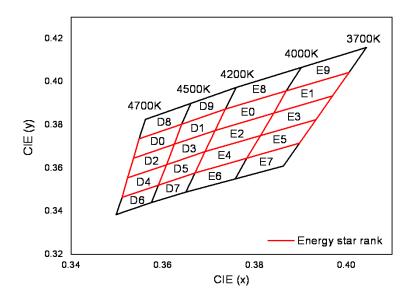
### CIE Chromaticity Diagram (Cool white), $T_j = 25 \, ^{\circ} C$ , $I_F = 350 mA$



A	70	А	1	A	2	A	.3	A	4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3028	0.3304	0.3115	0.3393	0.3041	0.3240	0.3126	0.3324	0.3055	0.3177
0.3041	0.3240	0.3126	0.3324	0.3055	0.3177	0.3136	0.3256	0.3068	0.3113
0.3426	0.3324	0.3210	0.3408	0.3136	0.3256	0.3216	0.3334	0.3146	0.3187
0.3115	0.3393	0.3205	0.3481	0.3126	0.3324	0.3210	0.3408	0.3136	0.3256
Α	5	Α	6	А	7	A	8	А	9
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3136	0.3256	0.3068	0.3113	0.3146	0.3187	0.3082	0.3046	0.3155	0.3120
0.3146	0.3187	0.3082	0.3046	0.3155	0.3120	0.3096	0.2980	0.3164	0.3046
0.3221	0.3261	0.3155	0.3120	0.3225	0.3190	0.3164	0.3046	0.3230	0.3110
0.3216	0.3334	0.3146	0.3187	0.3221	0.3261	0.3155	0.3120	0.3225	0.3190
В	0	В		В	2	_	3	В	4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3207	0.3462	0.3292	0.3539	0.3212	0.3389	0.3293	0.3461	0.3217	0.3316
0.3212	0.3389	0.3293	0.3461	0.3217	0.3316	0.3293	0.3384	0.3222	0.3243
0.3293	0.3461	0.3373	0.3534	0.3293	0.3384	0.3369	0.3451	0.3294	0.3306
0.3292	0.3539	0.3376	0.3616	0.3293	0.3461	0.3373	0.3534	0.3293	0.3384
	5		6		7		8	В	
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
CIE x 0.3293	CIE y 0.3384	CIE x 0.3222	CIE y 0.3243	CIE x 0.3294	CIE y 0.3306	CIE x 0.3200	CIE y 0.3572	CIE x 0.3290	CIE y 0.3656
CIE x 0.3293 0.3294	CIE y 0.3384 0.3306	CIE x 0.3222 0.3226	CIE y 0.3243 0.3178	CIE x 0.3294 0.3295	CIE y 0.3306 0.3234	CIE x 0.3200 0.3207	CIE y 0.3572 0.3462	CIE x 0.3290 0.3292	CIE y 0.3656 0.3539
CIE x 0.3293 0.3294 0.3366	CIE y 0.3384 0.3306 0.3369	CIE x 0.3222 0.3226 0.3295	CIE y 0.3243 0.3178 0.3234	CIE x 0.3294 0.3295 0.3364	CIE y 0.3306 0.3234 0.3288	CIE x 0.3200 0.3207 0.3292	CIE y 0.3572 0.3462 0.3539	CIE x 0.3290 0.3292 0.3376	CIE y 0.3656 0.3539 0.3616
CIE x 0.3293 0.3294 0.3366 0.3369	CIE y 0.3384 0.3306 0.3369 0.3451	CIE x 0.3222 0.3226 0.3295 0.3294	CIE y 0.3243 0.3178 0.3234 0.3306	CIE x 0.3294 0.3295 0.3364 0.3366	CIE y 0.3306 0.3234 0.3288 0.3369	CIE x 0.3200 0.3207 0.3292 0.3290	CIE y 0.3572 0.3462 0.3539 0.3656	CIE x 0.3290 0.3292 0.3376 0.3381	CIE y 0.3656 0.3539 0.3616 0.3740
CIE x 0.3293 0.3294 0.3366 0.3369	CIE y 0.3384 0.3306 0.3369 0.3451	CIE x 0.3222 0.3226 0.3295 0.3294	CIE y 0.3243 0.3178 0.3234 0.3306	CIE x 0.3294 0.3295 0.3364 0.3366	CIE y 0.3306 0.3234 0.3288 0.3369	CIE x 0.3200 0.3207 0.3292 0.3290	CIE y 0.3572 0.3462 0.3539 0.3656	CIE x 0.3290 0.3292 0.3376 0.3381	CIE y 0.3656 0.3539 0.3616 0.3740
CIE x 0.3293 0.3294 0.3366 0.3369	CIE y 0.3384 0.3306 0.3369 0.3451	CIE x 0.3222 0.3226 0.3295 0.3294	CIE y 0.3243 0.3178 0.3234 0.3306	CIE x 0.3294 0.3295 0.3364 0.3366	CIE y 0.3306 0.3234 0.3288 0.3369	CIE x 0.3200 0.3207 0.3292 0.3290	CIE y 0.3572 0.3462 0.3539 0.3656	CIE x 0.3290 0.3292 0.3376 0.3381	CIE y 0.3656 0.3539 0.3616 0.3740
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376	CIE y 0.3384 0.3306 0.3369 0.3451 CIE y 0.3616	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463	CIE y 0.3243 0.3178 0.3234 0.3306 1 CIE y 0.3687	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3373	CIE y 0.3384 0.3306 0.3369 0.3451 CIE y 0.3616 0.3534	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456	CIE y 0.3243 0.3178 0.3234 0.3306 11 CIE y 0.3687 0.3601	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3373 0.3456	CIE y 0.3384 0.3306 0.3369 0.3451 CIE y 0.3616 0.3534 0.3601	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539	CIE y 0.3243 0.3178 0.3234 0.3306 1 CIE y 0.3687 0.3601 0.3669	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3373 0.3456 0.3463	CIE y 0.3384 0.3306 0.3369 0.3451 CIE y 0.3616 0.3534 0.3601 0.3687	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539 0.3552	CIE y 0.3243 0.3178 0.3234 0.3306 1 CIE y 0.3687 0.3601 0.3669 0.3760	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526 0.3539	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463	CIE y 0.3384 0.3306 0.3369 0.3451  CIE y 0.3616 0.3534 0.3601 0.3687	CIE x 0.3222 0.3226 0.3295 0.3294  CIE x 0.3463 0.3456 0.3539 0.3552	CIE y 0.3243 0.3178 0.3234 0.3306 31 CIE y 0.3687 0.3601 0.3669 0.3760	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601	CIE x 0.3200 0.3207 0.3292 0.3290  CIE x 0.3456 0.3448 0.3526 0.3539	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3373 0.3456 0.3463	CIE y 0.3384 0.3306 0.3369 0.3451  CIE y 0.3616 0.3534 0.3601 0.3687	CIE x 0.3222 0.3226 0.3295 0.3294  CIE x 0.3463 0.3456 0.3539 0.3552  CIE x	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601	CIE x 0.3200 0.3207 0.3292 0.3290  CIE x 0.3456 0.3448 0.3526 0.3539  CIE x	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463 CIE x 0.3448	CIE y 0.3384 0.3306 0.3369 0.3451  CIE y 0.3616 0.3534 0.3601 0.3687  CIE y 0.3514	CIE x 0.3222 0.3226 0.3295 0.3294  CIE x 0.3463 0.3456 0.3539 0.3552  CIE x 0.3366	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y 0.3369	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601 7 CIE y 0.3428	CIE x 0.3200 0.3207 0.3292 0.3290  CIE x 0.3456 0.3448 0.3526 0.3539  CIE x 0.3381	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y 0.3740	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463 CIE x 0.3448 0.3440	CIE y 0.3384 0.3306 0.3369 0.3451  CIE y 0.3616 0.3534 0.3601 0.3687  CIE y 0.3514 0.3428	CIE x 0.3222 0.3226 0.3295 0.3294  CIE x 0.3463 0.3456 0.3539 0.3552  CIE x 0.3366 0.3364	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y 0.3369 0.3288	CIE x 0.3294 0.3295 0.3364 0.3366  CIE x 0.3373 0.3369 0.3448 0.3456  CIE x 0.3440 0.3433	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601 7 CIE y 0.3428 0.3345	CIE x 0.3200 0.3207 0.3292 0.3290  CIE x 0.3456 0.3448 0.3526 0.3539  CIE x 0.3381 0.3376	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y 0.3740 0.3616	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448 CIE x 0.3470 0.3463	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514 9 CIE y 0.3810 0.3687
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463 CIE x 0.3448	CIE y 0.3384 0.3306 0.3369 0.3451  CIE y 0.3616 0.3534 0.3601 0.3687  CIE y 0.3514	CIE x 0.3222 0.3226 0.3295 0.3294  CIE x 0.3463 0.3456 0.3539 0.3552  CIE x 0.3366	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y 0.3369	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601 7 CIE y 0.3428	CIE x 0.3200 0.3207 0.3292 0.3290  CIE x 0.3456 0.3448 0.3526 0.3539  CIE x 0.3381	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y 0.3740	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514

## **Color Bin Structure**

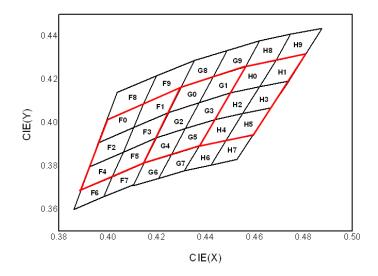
### CIE Chromaticity Diagram (Neutral white), $T_j = 25 \, ^{\circ}\!\! \text{C}$ , $I_F = 350 \text{mA}$



D	0	D	1	D	2	D	3	D	4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3548	0.3736	0.3641	0.3804	0.3536	0.3646	0.3625	0.3711	0.3524	0.3555
0.3536	0.3646	0.3625	0.3711	0.3524	0.3555	0.3608	0.3616	0.3512	0.3465
0.3625	0.3711	0.3714	0.3775	0.3608	0.3616	0.3692	0.3677	0.3590	0.3521
0.3641	0.3804	0.3736	0.3874	0.3625	0.3711	0.3714	0.3775	0.3608	0.3616
D	5	D	6	D	7	D	8	D	
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3608	0.3616	0.3512	0.3465	0.3590	0.3521	0.3562	0.3826	0.3661	0.3900
0.3590	0.3521	0.3497	0.3385	0.3575	0.3441	0.3548	0.3736	0.3641	0.3804
0.3670	0.3578	0.3575	0.3441	0.3650	0.3489	0.3641	0.3804	0.3736	0.3874
0.3692	0.3677	0.3590	0.3521	0.3670	0.3578	0.3661	0.3900	0.3760	0.3974
				0.00.0					
	0		1		2		3		4
E	0	E	1	E	2	E	3	E	4
CIE x	CIE y	CIE x	1 CIE y	CIE x	CIE y	CIE x	3 CIE y	CIE x	4 CIE y
CIE x 0.3736	CIE y 0.3874	CIE x 0.3869	CIE y 0.3958	CIE x 0.3714	CIE y 0.3775	CIE x 0.3842	3 CIE y 0.3855	CIE x 0.3692	CIE y 0.3677
CIE x 0.3736 0.3714	CIE y 0.3874 0.3775	CIE x 0.3869 0.3842	CIE y 0.3958 0.3855	CIE x 0.3714 0.3692	CIE y 0.3775 0.3677	CIE x 0.3842 0.3813	3 CIE y 0.3855 0.3751	CIE x 0.3692 0.3670	4 CIE y 0.3677 0.3578
CIE x 0.3736 0.3714 0.3842 0.3869	CIE y 0.3874 0.3775 0.3855	CIE x 0.3869 0.3842 0.3970 0.4006	CIE y 0.3958 0.3855 0.3935	CIE x 0.3714 0.3692 0.3813 0.3842	CIE y 0.3775 0.3677 0.3751	CIE x 0.3842 0.3813 0.3934 0.3970	CIE y 0.3855 0.3751 0.3825	CIE x 0.3692 0.3670 0.3783 0.3813	4 CIE y 0.3677 0.3578 0.3646
CIE x 0.3736 0.3714 0.3842 0.3869	CIE y 0.3874 0.3775 0.3855 0.3958	CIE x 0.3869 0.3842 0.3970 0.4006	CIE y 0.3958 0.3855 0.3935 0.4044	CIE x 0.3714 0.3692 0.3813 0.3842	CIE y 0.3775 0.3677 0.3751 0.3855	CIE x 0.3842 0.3813 0.3934 0.3970	3 CIE y 0.3855 0.3751 0.3825 0.3935	CIE x 0.3692 0.3670 0.3783 0.3813	CIE y 0.3677 0.3578 0.3646 0.3751
CIE x 0.3736 0.3714 0.3842 0.3869	CIE y 0.3874 0.3775 0.3855 0.3958	CIE x 0.3869 0.3842 0.3970 0.4006	CIE y 0.3958 0.3855 0.3935 0.4044	CIE x 0.3714 0.3692 0.3813 0.3842	CIE y 0.3775 0.3677 0.3751 0.3855	CIE x 0.3842 0.3813 0.3934 0.3970	3 CIE y 0.3855 0.3751 0.3825 0.3935	CIE x 0.3692 0.3670 0.3783 0.3813	CIE y 0.3677 0.3578 0.3646 0.3751
CIE x 0.3736 0.3714 0.3842 0.3869	CIE y 0.3874 0.3775 0.3855 0.3958	CIE x 0.3869 0.3842 0.3970 0.4006	CIE y 0.3958 0.3855 0.3935 0.4044 6 CIE y	CIE x 0.3714 0.3692 0.3813 0.3842 E	CIE y 0.3775 0.3677 0.3751 0.3855 7	CIE x 0.3842 0.3813 0.3934 0.3970	3 CIE y 0.3855 0.3751 0.3825 0.3935 8 CIE y	CIE x 0.3692 0.3670 0.3783 0.3813	CIE y 0.3677 0.3578 0.3646 0.3751 9
CIE x 0.3736 0.3714 0.3842 0.3869 CIE x 0.3813	CIE y 0.3874 0.3775 0.3855 0.3958 5 CIE y 0.3751	CIE x 0.3869 0.3842 0.3970 0.4006 CIE x 0.3670	CIE y 0.3958 0.3855 0.3935 0.4044 6 CIE y 0.3578	CIE x 0.3714 0.3692 0.3813 0.3842 CIE x 0.3783	CIE y 0.3775 0.3677 0.3751 0.3855 7 CIE y 0.3646	CIE x 0.3842 0.3813 0.3934 0.3970 E CIE x 0.3760	3 CIE y 0.3855 0.3751 0.3825 0.3935 8 CIE y 0.3974	CIE x 0.3692 0.3670 0.3783 0.3813 E CIE x 0.3902	CIE y 0.3677 0.3578 0.3646 0.3751 9 CIE y 0.4067

## **Color Bin Structure**

### CIE Chromaticity Diagram (Warm white), $T_j = 25 \, ^{\circ}\!\!\! \mathrm{C}$ , $I_F = 350 \mathrm{mA}$

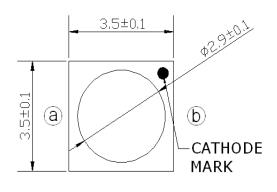


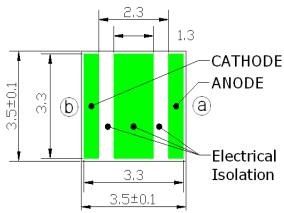
F	0	F	1	F	2	F	3	F	4
CIE x	CIE y	CIE x	CIE y						
0.3996	0.4015	0.4146	0.4089	0.3960	0.3907	0.4104	0.3978	0.3925	0.3798
0.3960	0.3907	0.4104	0.3978	0.3925	0.3798	0.4062	0.3865	0.3889	0.3690
0.4104	0.3978	0.4248	0.4048	0.4062	0.3865	0.4198	0.3931	0.4017	0.3751
0.4146	0.4089	0.4299	0.4165	0.4104	0.3978	0.4248	0.4048	0.4062	0.3865
F		F	· .		7		8	F	
CIE x	CIE y	CIE x	CIE y						
0.4062	0.3865	0.3889	0.3690	0.4017	0.3751	0.4037	0.4140	0.4197	0.4217
0.4017	0.3751	0.3860	0.3600	0.3983	0.3660	0.3996	0.4015	0.4146	0.4089
0.4147	0.3814	0.3983	0.3660	0.4104	0.3715	0.4146	0.4089	0.4299	0.4165
0.4198	0.3931	0.4017	0.3751	0.4147	0.3814	0.4197	0.4217	0.4354	0.4288
	0	G		_	2	_	3	, and the second se	4
CIE x	CIE y	CIE x	CIE y						
0.4299	0.4165	0.4430	0.4212	0.4248	0.4048	0.4374	0.4093	0.4198	0.3931
0.4248	0.4048	0.4374	0.4093	0.4198	0.3931	0.4317	0.3973	0.4147	0.3814
0.4374	0.4093	0.4499	0.4138	0.4317	0.3973	0.4436	0.4015	0.4259	0.3853
0.4430	0.4212	0.4562	0.4260	0.4374	0.4093	0.4499	0.4138	0.4317	0.3973
G CIE ::			6		7	_	8 OIF	CIE »	
CIE x	CIE y	CIE x	CIE y						
0.4317	0.3973	0.4147	0.3814	0.4259	0.3853	0.4354	0.4288	0.4487	0.4333
0.4259 0.4373	0.3853 0.3893	0.4102 0.4207	0.3710 0.3744	0.4207 0.4312	0.3744 0.3778	0.4299 0.4430	0.4165 0.4212	0.4430 0.4562	0.4212 0.4260
0.4373	0.3693	0.4207	0.3744	0.4312	0.3778	0.4487	0.4212	0.4562	0.4260
0.4436 H		0.4239			0.3693		0.4555		0.4376
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE v	CIE x	CIE y
0.4562	0.4260	0.4687	0.4289	0.4499	0.4138	0.4620	0.4166	0.4436	0.4015
0.4499	0.4138	0.4620	0.4166	0.4436	0.4015	0.4551	0.4042	0.4373	0.3893
0.4620	0.4166	0.4740	0.4194	0.4551	0.4042	0.4666	0.4069	0.4483	0.3919
0.4687	0.4289	0.4810	0.4319	0.4620	0.4166	0.4740	0.4194	0.4551	0.4042
Н		Н			7	Н	8	Н	
CIE x	CIE y	CIE x	CIE y						
0.4551	0.4042	0.4373	0.3893	0.4483	0.3919	0.4619	0.4378	0.4747	0.4410
0.4483	0.3919	0.4312	0.3778	0.4422	0.3805	0.4562	0.4260	0.4687	0.4289
0.4593	0.3944	0.4422	0.3805	0.4527	0.3830	0.4687	0.4289	0.4810	0.4319
0.4666	0.4069	0.4483	0.3919	0.4593	0.3944	0.4747	0.4410	0.4875	0.4435

## **Mechanical Dimensions**

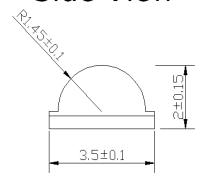
# Top View

# **Bottom View**

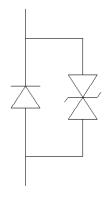




# Side View



# Circuit



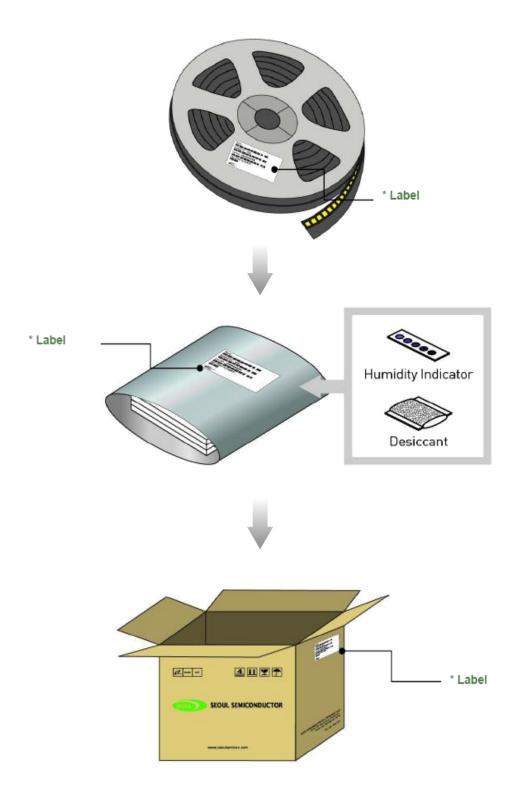
#### Notes:

(1) All dimensions are in millimeters.

(2) Scale: none

(3) Undefined tolerance is  $\pm 0.1$ mm

## **Emitter Tape & Reel Packaging**



### **Product Nomenclature**

 $RANK: Z_1Z_2Z_2Z_3$ 

**QUANTITY: 1000** 

SSC PART NUMBER : X<sub>1</sub>X<sub>2</sub>X<sub>3</sub>-X<sub>4</sub>X<sub>5</sub>-X<sub>6</sub>X<sub>7</sub>-X<sub>8</sub>X<sub>9</sub>

| 1881 | 1881 | 1881 | 1882 | 1883 | 1883 | 1884 | 1884 | 1884 | 1884 | 1884 | 1884 | 1884 | 1884 | 1884 | 1884



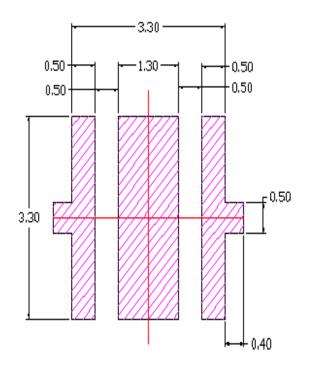
Table 8. Part Numbering System :  $X_1X_2X_3 - X_4X_5 - X_6X_7 - X_8X_9$ 

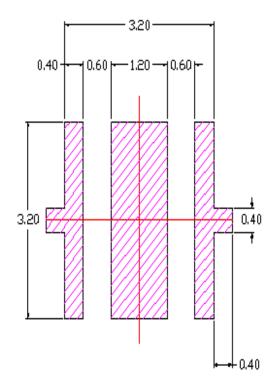
Part Number Code	Description	Part Number	Value
<b>X</b> <sub>1</sub>	Company	S	
X <sub>2</sub>	Z-Power LED series number	Z	
X <sub>3</sub>	PKG series	5	
X <sub>4</sub>	PKG series	М	M series
X <sub>5</sub>	Revision number	1	New version
X <sub>6</sub> X <sub>7</sub>	Color Specification	WO	Pure white
		WN	Neutral white
		WW	Warm white
X <sub>8</sub> X <sub>9</sub>	Color Specification	C8	CRI (min.) 80
		C9	CRI (min.) 90
		00	The others

Lot Number Code	Description	
Y <sub>1</sub>	Year	
Y <sub>2</sub>	Month	
<b>Y</b> <sub>3</sub>	Day	
Y <sub>4</sub>	Production area	
<b>Y</b> <sub>5</sub>	Mass order	
Y <sub>6</sub>	Taping number	
Y <sub>7</sub>	Reel number	
Y <sub>8</sub>	Internal management number	

[1]  $Z_1$ : Flux rank  $Z_2$ : Chromaticity  $Z_3$ : VF rank

## **Recommended Solder Pad**





Recommended PCB Solder Pad

Recommended Stencil Pattern

#### Notes:

- (1) All dimensions are in millimeters.
- (2) Scale: none
- (3) This drawing without tolerances are for reference only
- (4) Undefined tolerance is  $\pm 0.1$ mm

## **Reflow Soldering Characteristics**

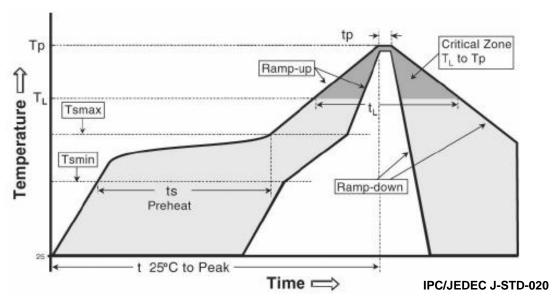


Table 10.

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (Tsmax to Tp)	3° C/second max.	3° C/second max.
Preheat - Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (Tsmin to Tsmax) (ts)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds
Time maintained above: - Temperature (TL) - Time (tL)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (Tp)	215℃	260℃
Time within 5°C of actual Peak Temperature (tp)2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

#### Caution

- (1) Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.

## **Handling of Silicone Resin for LEDs**

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.





- (2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.
- (3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.
- (4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust. As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.
- (5) SSC suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.
- (6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this product with acid or sulfur material in sealed space.
- (7) Avoid leaving fingerprints on silicone resin parts.

### **Precaution for Use**

#### (1) Storage

To avoid the moisture penetration, we recommend storing  $\,$  Z5 Series LEDs in a dry box with a desiccant . The recommended storage temperature range is 5  $^{\circ}$ C to 30  $^{\circ}$ C and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging

Use proper SMD techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Recommend conditions after opening the package
  - Sealing / Temperature : 5 ~ 40 °C Humidity : less than RH30%
- b. If the package has been opened more than 1 year (MSL 2) or the color of the desiccant changes, components should be dried for 10-12hr at  $60\pm5$  °C
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.
- (10) LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from Seoul Semiconductor. A sealed container with a nitrogen atmosphere should be used for storage.
- (11) The appearance and specifications of the product may be modified for improvement without notice.
- (12) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.

### **Precaution for Use**

- (13) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.
- (14) The slug is electrically isolated.
- (15) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (16) The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the rev erse voltage is applied to LED, migration can be generated resulting in LED damage.
- (17) LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.
- a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

#### Environmental controls:

- Humidity control (ESD gets worse in a dry environment)

### **Precaution for Use**

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package
   (If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)
- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.
- c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:
  - A surge protection circuit
  - An appropriately rated over voltage protection device
  - A current limiting device



## **Company Information**

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#### **Company Information**

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

#### **Legal Disclaimer**

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